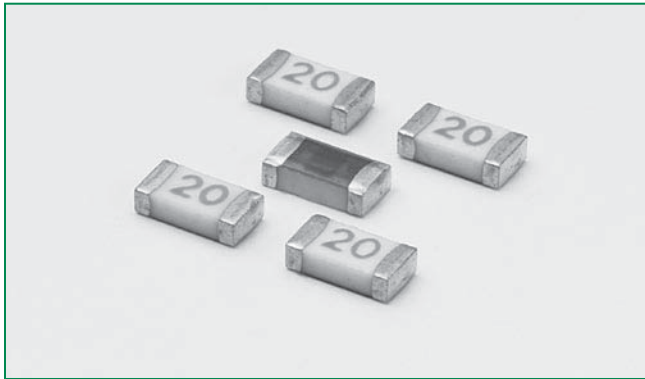


RoHS  HF **501 Series – High Current 1206 Fast-Acting Fuse**





Description

This 100% Lead Free, RoHS compliant and Halogen Free fuse series has been designed specifically to provide over current protection to circuits that see high working ambient temperatures (up to 150°C).

The general design ensures excellent temperature stability and performance reliability.

In addition to this, the high i^2t values typical of the Littelfuse Ceramic fuse family ensure high inrush current withstand capability.

Agency Approvals

| AGENCY | AGENCY FILE NUMBER | AMPERE RANGE |
|---|--------------------|--------------|
|  | E10480 | 10A - 20A |
|  | LR29862 | 10A - 20A |

Features

- Operating Temperature -55°C to +150°C
- 100% Lead-Free and RoHS compliant
- Designed to provide over current protection in high current voltage regulator module (VRM) applications
- Suitable for both leaded and lead-free reflow / wave soldering



Electrical Characteristics for Series

| % of Ampere Rating | Ampere Rating | Opening Time at 25°C |
|--------------------|---------------|----------------------|
| 100% | 10A ~ 20A | 4 hours Minimum |
| 350% | 10A ~ 20A | 5 secs. Maximum |

Applications

- Voltage Regulator Module (VRM) Equipment
- Notebook PC
- DC-DC Converter

Electrical Specifications by Item

| Ampere Rating (A) | Amp Code | Max. Voltage Rating (V) | Interrupt Rating (DC) ¹ | Nominal Resistance (Ohms) ² | Nominal Melting I ² T (A ² Sec.) ³ | Nominal Voltage Drop At Rated Current (V) ⁴ | Nominal Power Dissipation At Rated Current (W) | Agency Approvals | |
|-------------------|----------|-------------------------|------------------------------------|--|---|--|--|---|---|
| | | | | | | | |  |  |
| 10A | 010. | 24 | 150 A @ 24 V DC | 0.00427 | 10.385 | 0.05679 | 0.5679 | x | x |
| 12A | 012. | 24 | | 0.00321 | 20.341 | 0.04891 | 0.5870 | x | x |
| 15A | 015. | 24 | | 0.00250 | 36.100 | 0.04605 | 0.6908 | x | x |
| 20A | 020. | 24 | | 0.00200 | 54.760 | 0.05936 | 1.1871 | x | x |

Notes:

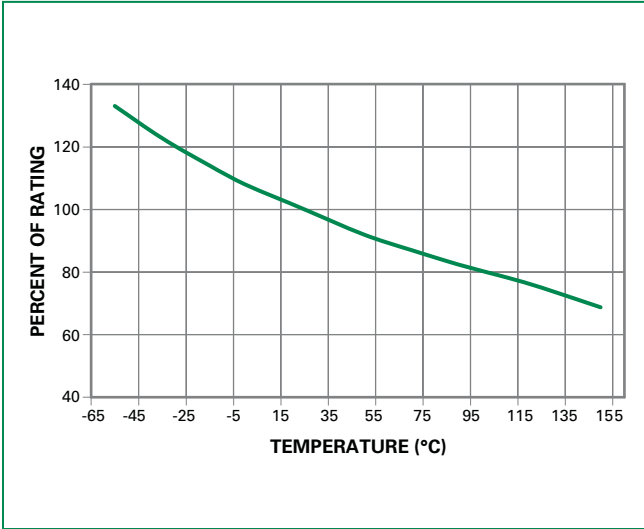
- DC Interrupt Rating tested at rated voltage with time constant <0.8 msec.
- Nominal Resistance measured with <10% rated current.
- Nominal Melting I²t measured at 1 msec opening time. For other I²t data refer to chart.
- Nominal Voltage Drop measured at rated current after temperature has stabilized and with fuse mounted on board with 3-oz Cu trace.

Devices designed to carry rated current for 4 hours minimum. It is recommended that devices be operated continuously at no more than 80% rated current. See "Temperature Re-Rating Curve" for additional re-rating information.

Devices designed to be mounted with marking code facing up.

501 Series

Temperature Derating Curve



Note:

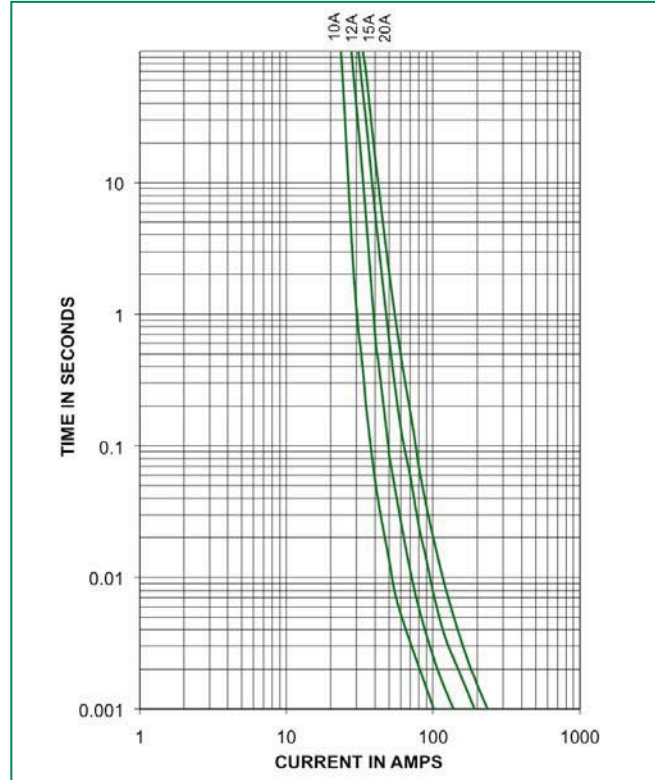
- Derating depicted in this curve is in addition to the standard derating of 20% for continuous operation.

Example:

For continuous operation at 75 degrees celsius, the fuse should be derated as follows:

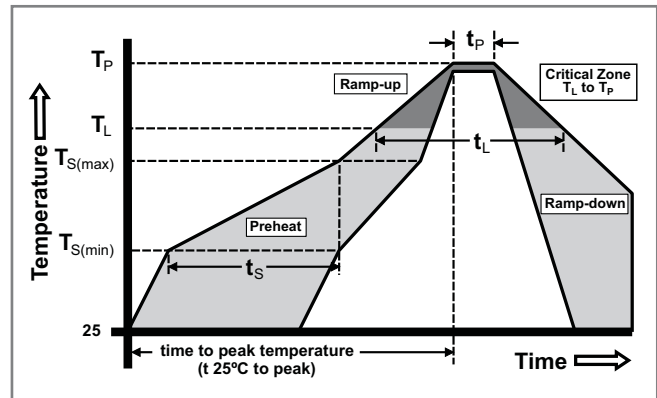
$$I = (0.80)(0.85)I_{RAT} = (0.68)I_{RAT}$$

Average Time Current Curves



Soldering Parameters

| | | |
|--|------------------------------------|------------------|
| Reflow Condition | Pb – Free assembly | |
| Pre Heat | - Temperature Min ($T_{s(min)}$) | 150°C |
| | - Temperature Max ($T_{s(max)}$) | 200°C |
| | - Time (Min to Max) (t_s) | 60 – 180 secs |
| Average ramp up rate (Liquidus Temp (T_L) to peak) | 3°C/second max | |
| $T_{s(max)}$ to T_L - Ramp-up Rate | 5°C/second max | |
| Reflow | - Temperature (T_L) (Liquidus) | 217°C |
| | - Temperature (t_L) | 60 – 150 seconds |
| Peak Temperature (T_p) | 260 ^{+0/-5} °C | |
| Time within 5°C of actual peak Temperature (t_p) | 10 – 30 seconds | |
| Ramp-down Rate | 6°C/second max | |
| Time 25°C to peak Temperature (T_p) | 8 minutes Max. | |
| Do not exceed | 260°C | |



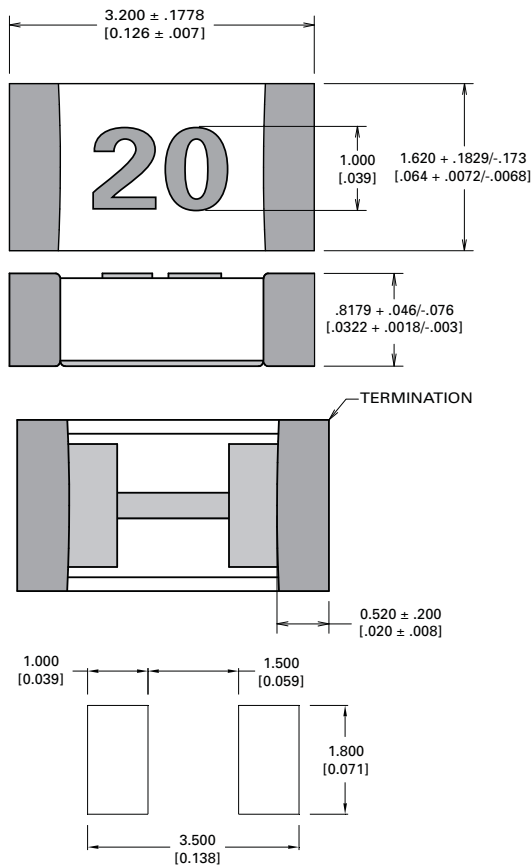
| | |
|----------------|------------------------|
| Wave Soldering | 260°C, 10 seconds max. |
|----------------|------------------------|

Product Characteristics

| | |
|-----------------------------------|--|
| Materials | Body: Advanced Ceramic Terminations: Ag / Ni / Sn (100% Lead-Free) Element Cover Coating: Lead-Free Glass |
| Moisture Sensitivity Level | IPC/JEDEC J-STD-020C, Level 1 |
| Solderability | IPC/ECA/JEDEC J-STD-002C, Condition B |
| Humidity Test | MIL-STD-202, Method 103B, Conditions D |
| ESD Immunity | IEC 61000-4-2, 8KV Direct |
| Resistance to Solvents | MIL-STD-202, Method 210F, Condition B |

| | |
|-------------------------------------|---------------------------------------|
| Moisture Resistance | MIL-STD-202, Method 106G |
| Thermal Shock | MIL-STD-202, Method 107G, Condition B |
| Mechanical Shock | MIL-STD-202, Method 213B, Condition A |
| Vibration | MIL-STD-202, Method 201A |
| Vibration, High Frequency | MIL-STD-202, Method 204D, Condition D |
| Dissolution of Metallization | IPC/ECA/JEDEC J-STD-002C, Condition D |
| Terminal Strength | IEC 60127-4 |

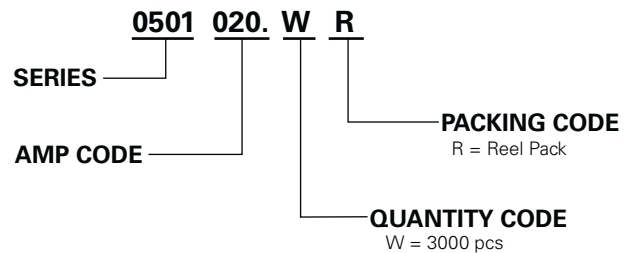
Dimensions



Part Marking System

| Amp Code | Marking Code |
|----------|--------------|
| 010. | 10 |
| 012. | 12 |
| 015. | 15 |
| 020. | 20 |

Part Numbering System



Packaging

| Packaging Option | Packaging Specification | Quantity | Quantity & Packaging Code |
|-------------------|-----------------------------|----------|---------------------------|
| 8mm Tape and Reel | EIA-481-1 (IEC 286, part 3) | 3000 | WR |

